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(12) **United States Design Patent**  
**Cuellar et al.**

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(54) **COMBINED MEMORY CARD AND CARRIER ASSEMBLY**

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(\*\*) Term: **14 Years**

(21) Appl. No.: **29/236,910**

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**Related U.S. Application Data**

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(51) **LOC (8) Cl.** ..... **14-02**

(52) **U.S. Cl.** ..... **D14/436**

(58) **Field of Classification Search** ..... D14/435-8,  
D14/478-80; 361/736-7, 686, 752; 257/678-9;  
40/124.01; 283/75-6, 901; 235/487-95, 441-3,  
235/375; 439/135, 140, 76.1; D8/347  
See application file for complete search history.

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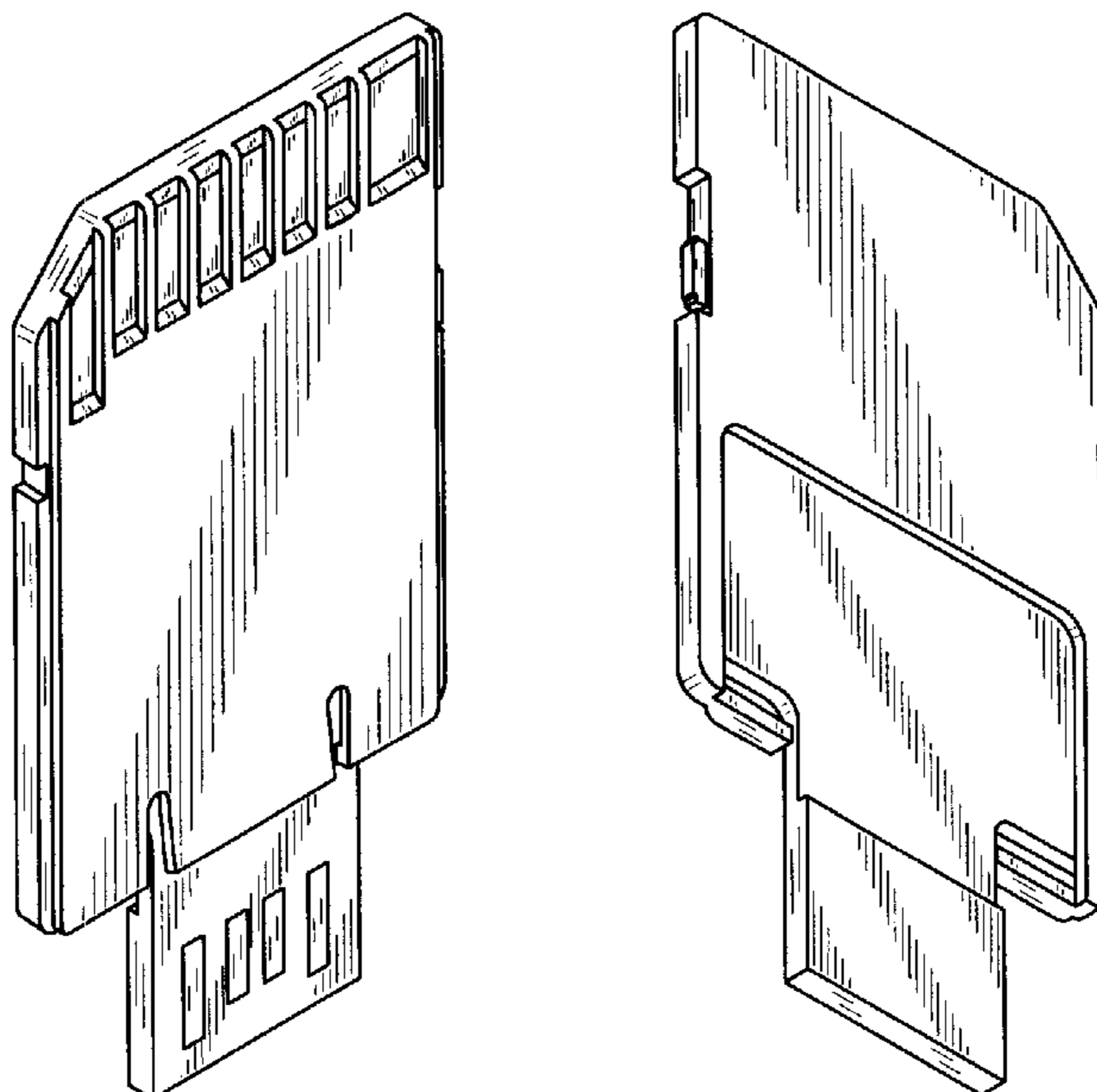
(57) **CLAIM**

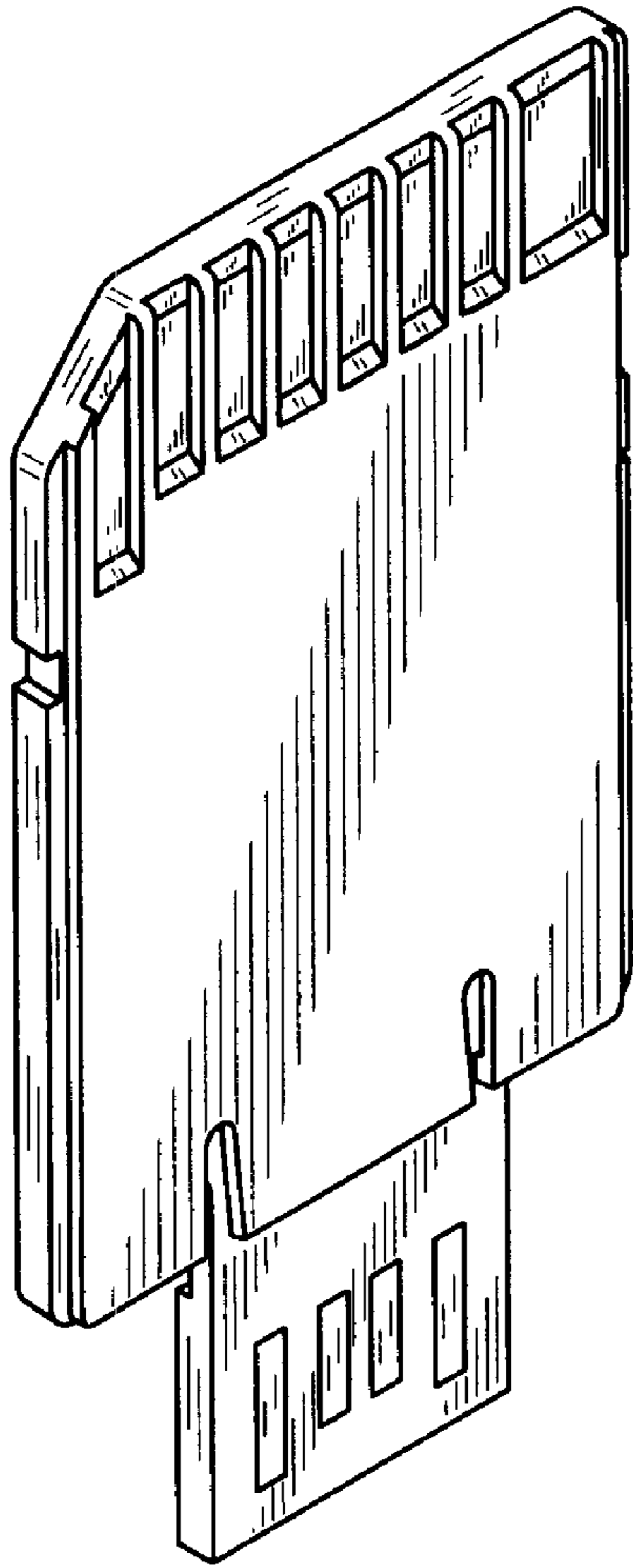
The ornamental design for a combined memory card and carrier assembly, as shown and described.

**DESCRIPTION**

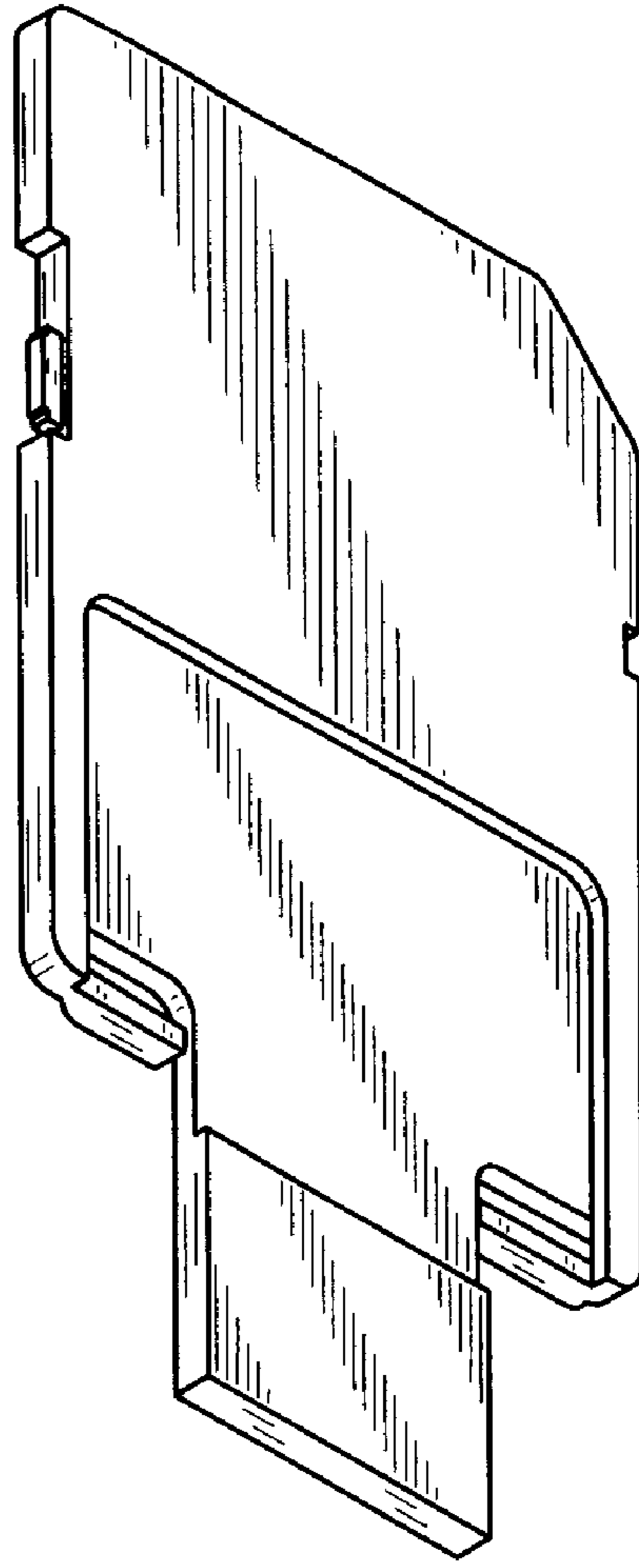
FIG. 1 is a front, top, left side isometric view of the combined memory card and carrier assembly;  
FIG. 2 is a rear, bottom, right side isometric view thereof;  
FIG. 3 is a front elevational view thereof;  
FIG. 4 is a right side elevational view thereof;  
FIG. 5 is a top plan view thereof;  
FIG. 6 is a rear elevational view thereof;  
FIG. 7 is a left side elevational view thereof; and,  
FIG. 8 is a bottom plan view thereof.

**1 Claim, 2 Drawing Sheets**





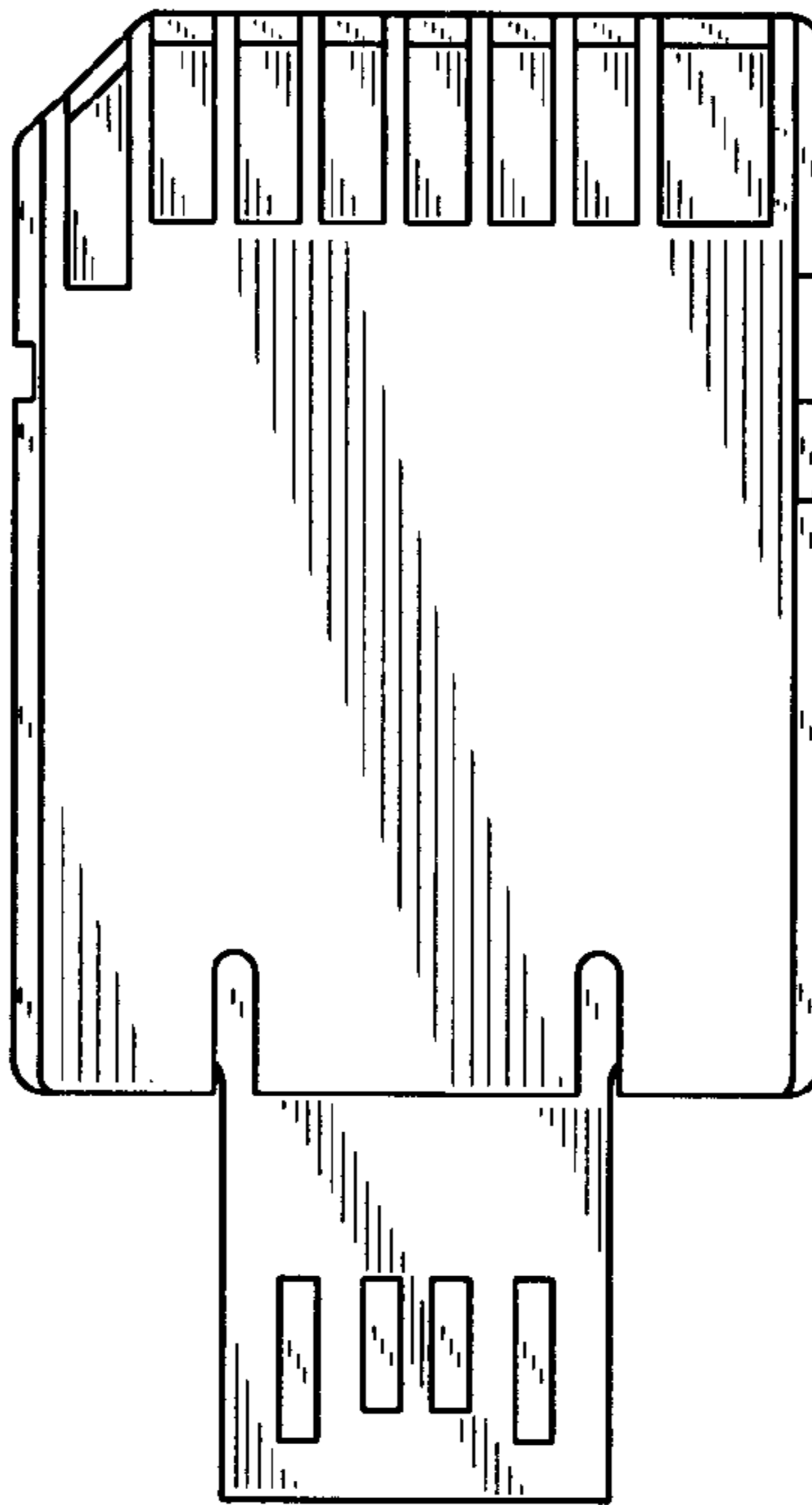
**FIG. 1**



**FIG. 2**



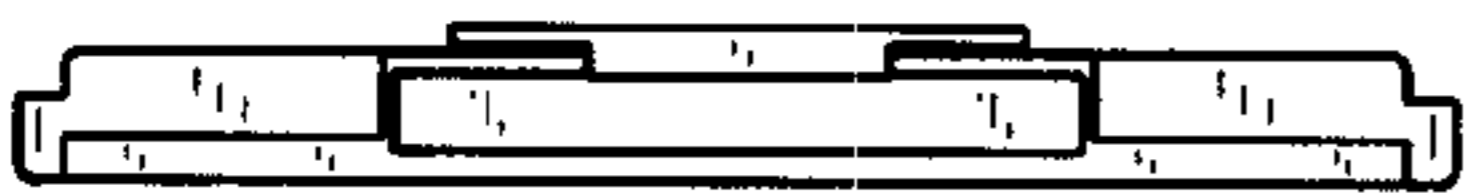
**FIG.\_5**



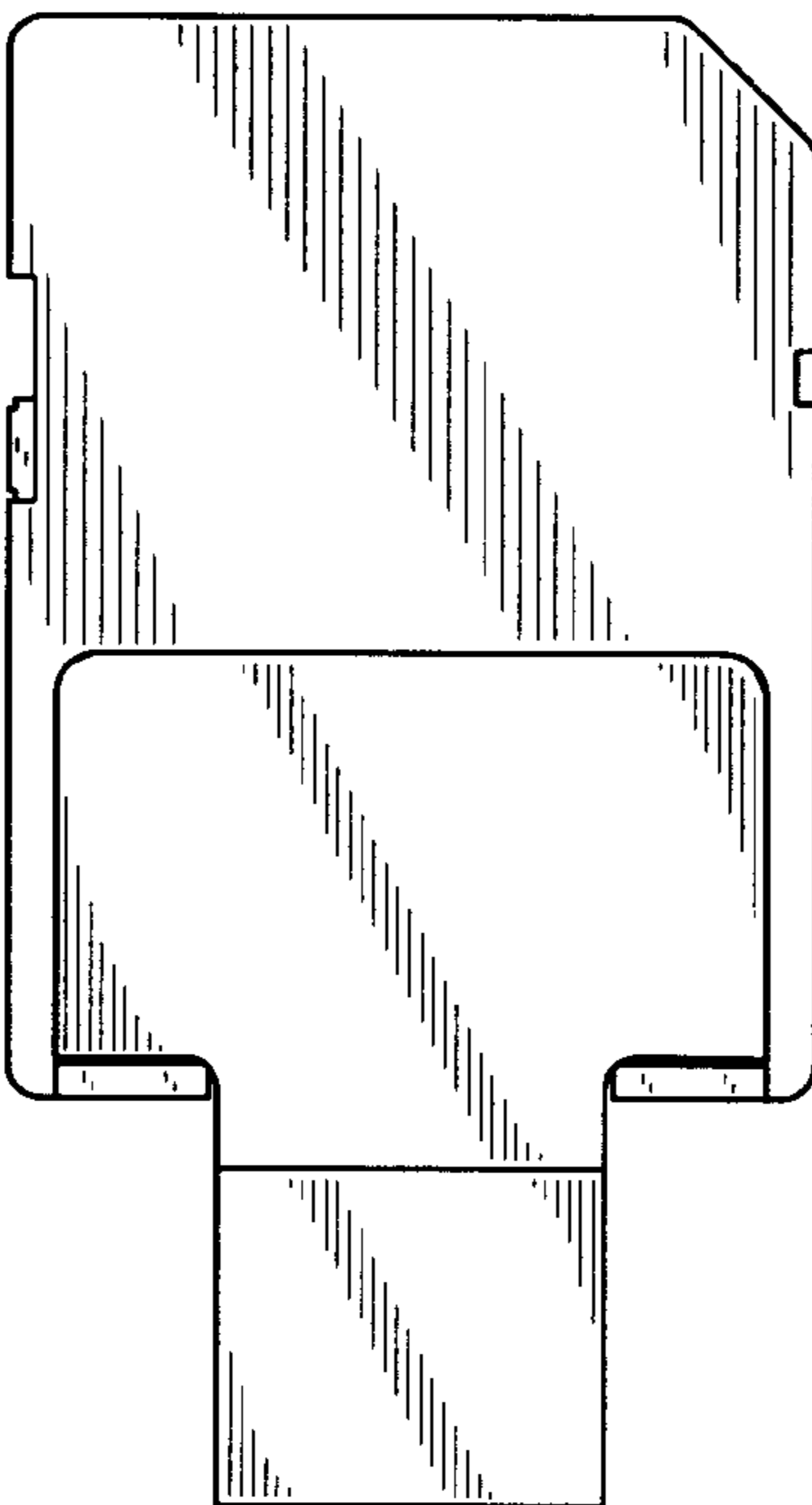
**FIG.\_3**



**FIG.\_4**



**FIG.\_8**



**FIG.\_6**



**FIG.\_7**